

ABSTRACT OF THE DISCLOSURE

A radiation-curable adhesive composition comprising at least one
5 tackifier resin and at least one radiation-curable composition is provided
wherein the tackifier resin comprises monomer repeating units from at least
one aromatic monomer and at least one acrylate monomer. Processes to
produce the radiation-curable adhesive composition as well as articles
10 comprising the radiation-curable adhesive compositions are also provided.

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